

L Number	Hits	Search Text	DB	Time stamp
1	3	((("6332569") or ("5341564") or ("6025258"))).PN.	USPAT	2004/09/13 18:15
2	1	("5735452").PN.	USPAT	2004/09/13 19:29
11	22	4630875.URPN.	USPAT	2004/09/13 19:04
50	35774	(socket or connector) and ((board or pwb or pcb) with (chip or die or device or package))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/13 20:02
51	40009	(socket or connector) and ((board or pwb or pcb) with ((integrated adj circuit) or ic or chip or die or device or package))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/13 19:32
52	27287	((socket or connector) and ((board or pwb or pcb) with ((integrated adj circuit) or ic or chip or die or device or package))) and (@ad<20001230)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/13 20:04
53	444	((socket or connector) and ((board or pwb or pcb) with ((integrated adj circuit) or ic or chip or die or device or package))) and (@ad<20001230) and ((bus or bar) near (power or vss or vdd))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/13 19:33
54	797	((male with (socket or connector)) with (chip or die or device or package)) and (board or pwb or pcb)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/13 20:04
55	603	((male with (socket or connector)) with (chip or die or device or package)) and (board or pwb or pcb) and (@ad<20001230)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/13 20:04
56	386	((male near (socket or connector)) with (chip or die or device or package)) and (board or pwb or pcb)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/13 20:45
57	286	((male near (socket or connector)) with (chip or die or device or package)) and (board or pwb or pcb) and (@ad<20001230)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/13 20:45
58	27	((male near (socket or connector)) with (chip or die)) and (board or pwb or pcb)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/13 20:46
59	18	((male near (socket or connector)) with (chip or die)) and (board or pwb or pcb) and (@ad<20001230)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/13 20:46
60	45	((male near (socket or connector)) with (chip or semiconductor or die)) and (board or pwb or pcb)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/13 21:15
61	25	((male near (socket or connector)) with (chip or semiconductor or die)) and (board or pwb or pcb) and (@ad<20001230)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/13 21:15
62	15	5365686.URPN.	USPAT	2004/09/13 21:06
63	15	5365686.URPN.	USPAT	2004/09/13 21:07

64	8	("3691312" "3857191" "4541188" "4648086" "4745695" "4791741" "4934079" "5063698").PN.	USPAT	2004/09/13 21:07
65	50	((female near (socket or connector)) with (chip or semiconductor or die)) and (board or pwb or pcb)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/13 21:27
66	35	((female near (socket or connector)) with (chip or semiconductor or die)) and (board or pwb or pcb) and (@ad<20001230)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/13 21:28
67	22	((female near (socket or connector)) with (chip or semiconductor or die)) and (board or pwb or pcb) and (@ad<20001230)) not (((male near (socket or connector)) with (chip or semiconductor or die)) and (board or pwb or pcb) and (@ad<20001230))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/13 21:15
68	518	((female with male) with (chip or semiconductor or die)) and (board or pwb or pcb)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/13 21:28
69	411	((female with male) with (chip or semiconductor or die)) and (board or pwb or pcb) and (@ad<20001230)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/13 21:28
70	112	((female with male) with (chip or semiconductor or die)) and (board or pwb or pcb) and (@ad<20001230)) and power	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/13 21:30